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MC68HC908QY4
MC68HC908QT4
MC68HC908QY2
MC68HC908QT2
MC68HC908QY1
MC68HC908QT1

Data Sheet

M68HC08
Microcontrollers

MC68HC908QY4/D
Rev. 6
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freescale.com

MC68HC908QY4
MC68HC908QT4
MC68HC908QY2
MC68HC908QT2
MC68HC908QY1
MC68HC908QT1

Data Sheet

To provide the most up-to-date information, the revision of our documents on the World Wide Web will be the most current. Your printed copy may be an earlier revision. To verify you have the latest information available, refer to:

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Revision History

The following revision history table summarizes changes contained in this document. For your convenience, the page number designators have been linked to the appropriate location.

Revision History (Sheet 1 of 3)

Date	Revision Level	Description	Page Number(s)
September, 2002	N/A	Initial release	N/A
December, 2002	0.1	1.2 Features — Added 8-pin dual flat no lead (DFN) packages to features list.	19
		Figure 1-2. MCU Pin Assignments — Figure updated to include DFN packages.	21
		Figure 2-1. Memory Map — Clarified illegal address and unimplemented memory.	27
		Figure 2-2. Control, Status, and Data Registers — Corrected bit definitions for Port A Data Register (PTA) and Data Direction Register A (DDRA).	27
		Table 13-3. Interrupt Sources — Corrected vector addresses for keyboard interrupt and ADC conversion complete interrupt.	118
		Chapter 13 System Integration Module (SIM) — Removed reference to break status register as it is duplicated in break module.	113
		11.3.1 Internal Oscillator and 11.3.1.1 Internal Oscillator Trimming — Clarified oscillator trim option ordering information and what to expect with untrimmed device.	92
		Figure 11-5. Oscillator Trim Register (OSCTRIM) — Bit 1 designation corrected.	98
		Figure 15-13. Monitor Mode Circuit (Internal Clock, No High Voltage) — Diagram updated for clarity.	150
		Figure 12-1. I/O Port Register Summary — Corrected bit definitions for PTA7, DDRA7, and DDRA6.	99
		Figure 12-2. Port A Data Register (PTA) — Corrected bit definition for PTA7.	100
		Figure 12-3. Data Direction Register A (DDRA) — Corrected bit definitions for DDRA7 and DDRA6.	101
		Figure 12-6. Port B Data Register (PTB) — Corrected bit definition for PTB1	103
		Chapter 9 Keyboard Interrupt Module (KBI) — Section reworked after deletion of auto wakeup for clarity.	83
		Chapter 4 Auto Wakeup Module (AWU) — New section added for clarity.	49
		Figure 10-1. LVI Module Block Diagram — Corrected LVI stop representation.	87
		Chapter 16 Electrical Specifications — Extensive changes made to electrical specifications.	169
17.5 8-Pin Dual Flat No Lead (DFN) Package (Case #1452) — Added case outline drawing for DFN package.	177		
Chapter 17 Ordering Information and Mechanical Specifications — Added ordering information for DFN package.	185		
January, 2003	0.2	4.2 Features — Corrected third bulleted item.	49

Revision History (Sheet 2 of 3)

Date	Revision Level	Description	Page Number(s)
August, 2003	1.0	Reformatted to meet latest M68HC08 documentation standards	N/A
		Figure 1-1. Block Diagram — Diagram redrawn to include keyboard interrupt module and TCLK pin designator.	20
		Figure 1-2. MCU Pin Assignments — Added TCLK pin designator.	21
		Table 1-2. Pin Functions — Added TCLK pin description.	22
		Table 1-3. Function Priority in Shared Pins — Revised table for clarity and to add TCLK.	23
		Figure 2-1. Memory Map — Corrected names for the IRQ status and control register (INTSCR) bits 3–0.	26
		3.7.3 ADC Input Clock Register — Clarified bit description for the ADC clock prescaler bits.	47
		4.3 Functional Description — Updated periodic wakeup request values.	51
		Figure 6-1. COP Block Diagram — Reworked for clarity	59
		Chapter 8 External Interrupt (IRQ) — Corrected bit names for MODE, IRQF, ACK, and IMASK	77–79
		Chapter 14 Timer Interface Module (TIM) — Added TCLK function.	131–139
		15.3 Monitor Module (MON) — Updated with additional data.	147
Chapter 16 Electrical Specifications — Updated with additional data.	169–173		
October, 2003	2.0	Figure 2-2. Control, Status, and Data Registers — Deleted unimplemented areas from \$FFB0–\$FFBD and \$FFC2–\$FFCF as they are actually available. Also corrected \$FFBF designation from unimplemented to reserved.	27
		Figure 6-1. COP Block Diagram — Reworked for clarity	59
		6.3.2 STOP Instruction — Added subsection	60
		13.4.2 Active Resets from Internal Sources — Reworked notes for clarity.	111
		Table 13-2. Reset Recovery Timing — Replaced previous table with new information.	112
		Chapter 14 Timer Interface Module (TIM) — Updated with additional data.	131
		Figure 15-3. Break I/O Register Summary — Corrected bit designators for the BRKAR register	143
		15.3 Monitor Module (MON) — Clarified seventh bullet.	147
Table 17-1. MC Order Numbers — Corrected temperature and package designators.	175		
January, 2004	3.0	Figure 2-2. Control, Status, and Data Registers — Corrected reset state for the FLASH Block Protect Register at address location \$FFBE and the Internal Oscillator Trim Value at \$FFC0.	32
		Figure 2-5. FLASH Block Protect Register (FLBPR) — Restated reset state for clarity.	38

Revision History (Sheet 3 of 3)

Date	Revision Level	Description	Page Number(s)
November, 2004	4.0	Reformatted to meet current documentation standards	Throughout
		6.3.1 BUSCLKX4 — Clarified description of BUSCLKX4	58
		Chapter 7 Central Processor Unit (CPU) — In 7.7 Instruction Set Summary : Reworked definitions for STOP instruction Added WAIT instruction	70 71
		13.8.1 SIM Reset Status Register — Clarified SRSR flag setting	117
		14.9.1 TIM Status and Control Register — Added information to TSTOP note	127
		16.8 5-V Oscillator Characteristics — Added values for deviation from trimmed internal oscillator	155
		16.12 3-V Oscillator Characteristics — Added values for deviation from trimmed internal oscillator	158
July, 2005	5.0	Figure 5-2. Configuration Register 1 (CONFIG1) — Clarified bit definitions for COPRS.	54
		Chapter 8 External Interrupt (IRQ) — Reworked for clarification.	73
		11.3.4 RC Oscillator — Improved RC oscillator wording.	93
		12.1 Introduction — Added note pertaining to non-bonded port pins.	97
		17.3 Package Dimensions — Updated package information.	165
March, 2010	6.0	Clarify internal oscillator trim register information.	26, 27, 31, 34, 35, 38, 91, 96

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Chapter 1

General Description

1.1 Introduction

The MC68HC908QY4 is a member of the low-cost, high-performance M68HC08 Family of 8-bit microcontroller units (MCUs). The M68HC08 Family is a Complex Instruction Set Computer (CISC) with a Von Neumann architecture. All MCUs in the family use the enhanced M68HC08 central processor unit (CPU08) and are available with a variety of modules, memory sizes and types, and package types.

Table 1-1. Summary of Device Variations

Device	FLASH Memory Size	Analog-to-Digital Converter	Pin Count
MC68HC908QT1	1536 bytes	—	8 pins
MC68HC908QT2	1536 bytes	4 ch, 8 bit	8 pins
MC68HC908QT4	4096 bytes	4 ch, 8 bit	8 pins
MC68HC908QY1	1536 bytes	—	16 pins
MC68HC908QY2	1536 bytes	4 ch, 8 bit	16 pins
MC68HC908QY4	4096 bytes	4 ch, 8 bit	16 pins

1.2 Features

Features include:

- High-performance M68HC08 CPU core
- Fully upward-compatible object code with M68HC05 Family
- 5-V and 3-V operating voltages (V_{DD})
- 8-MHz internal bus operation at 5 V, 4-MHz at 3 V
- Trimmable internal oscillator
 - 3.2 MHz internal bus operation
 - 8-bit trim capability allows 0.4% accuracy⁽¹⁾
 - $\pm 25\%$ untrimmed
- Auto wakeup from STOP capability
- Configuration (CONFIG) register for MCU configuration options, including:
 - Low-voltage inhibit (LVI) trip point
- In-system FLASH programming
- FLASH security⁽²⁾

1. The oscillator frequency is guaranteed to $\pm 5\%$ over temperature and voltage range after trimming.

2. No security feature is absolutely secure. However, Freescale's strategy is to make reading or copying the FLASH difficult for unauthorized users.

General Description

- On-chip in-application programmable FLASH memory (with internal program/erase voltage generation)
 - MC68HC908QY4 and MC68HC908QT4 — 4096 bytes
 - MC68HC908QY2, MC68HC908QY1, MC68HC908QT2, and MC68HC908QT1 — 1536 bytes
- 128 bytes of on-chip random-access memory (RAM)
- 2-channel, 16-bit timer interface module (TIM)
- 4-channel, 8-bit analog-to-digital converter (ADC) on MC68HC908QY2, MC68HC908QY4, MC68HC908QT2, and MC68HC908QT4
- 5 or 13 bidirectional input/output (I/O) lines and one input only:
 - Six shared with keyboard interrupt function and ADC
 - Two shared with timer channels
 - One shared with external interrupt (IRQ)
 - Eight extra I/O lines on 16-pin package only
 - High current sink/source capability on all port pins
 - Selectable pullups on all ports, selectable on an individual bit basis
 - Three-state ability on all port pins
- 6-bit keyboard interrupt with wakeup feature (KBI)
- Low-voltage inhibit (LVI) module features:
 - Software selectable trip point in CONFIG register
- System protection features:
 - Computer operating properly (COP) watchdog
 - Low-voltage detection with reset
 - Illegal opcode detection with reset
 - Illegal address detection with reset
- External asynchronous interrupt pin with internal pullup ($\overline{\text{IRQ}}$) shared with general-purpose input pin
- Master asynchronous reset pin ($\overline{\text{RST}}$) shared with general-purpose input/output (I/O) pin
- Power-on reset
- Internal pullups on $\overline{\text{IRQ}}$ and $\overline{\text{RST}}$ to reduce external components
- Memory mapped I/O registers
- Power saving stop and wait modes
- MC68HC908QY4, MC68HC908QY2, and MC68HC908QY1 are available in these packages:
 - 16-pin plastic dual in-line package (PDIP)
 - 16-pin small outline integrated circuit (SOIC) package
 - 16-pin thin shrink small outline package (TSSOP)
- MC68HC908QT4, MC68HC908QT2, and MC68HC908QT1 are available in these packages:
 - 8-pin PDIP
 - 8-pin SOIC
 - 8-pin dual flat no lead (DFN) package

Features of the CPU08 include the following:

- Enhanced HC05 programming model
- Extensive loop control functions
- 16 addressing modes (eight more than the HC05)
- 16-bit index register and stack pointer
- Memory-to-memory data transfers
- Fast 8×8 multiply instruction
- Fast 16/8 divide instruction
- Binary-coded decimal (BCD) instructions
- Optimization for controller applications
- Efficient C language support

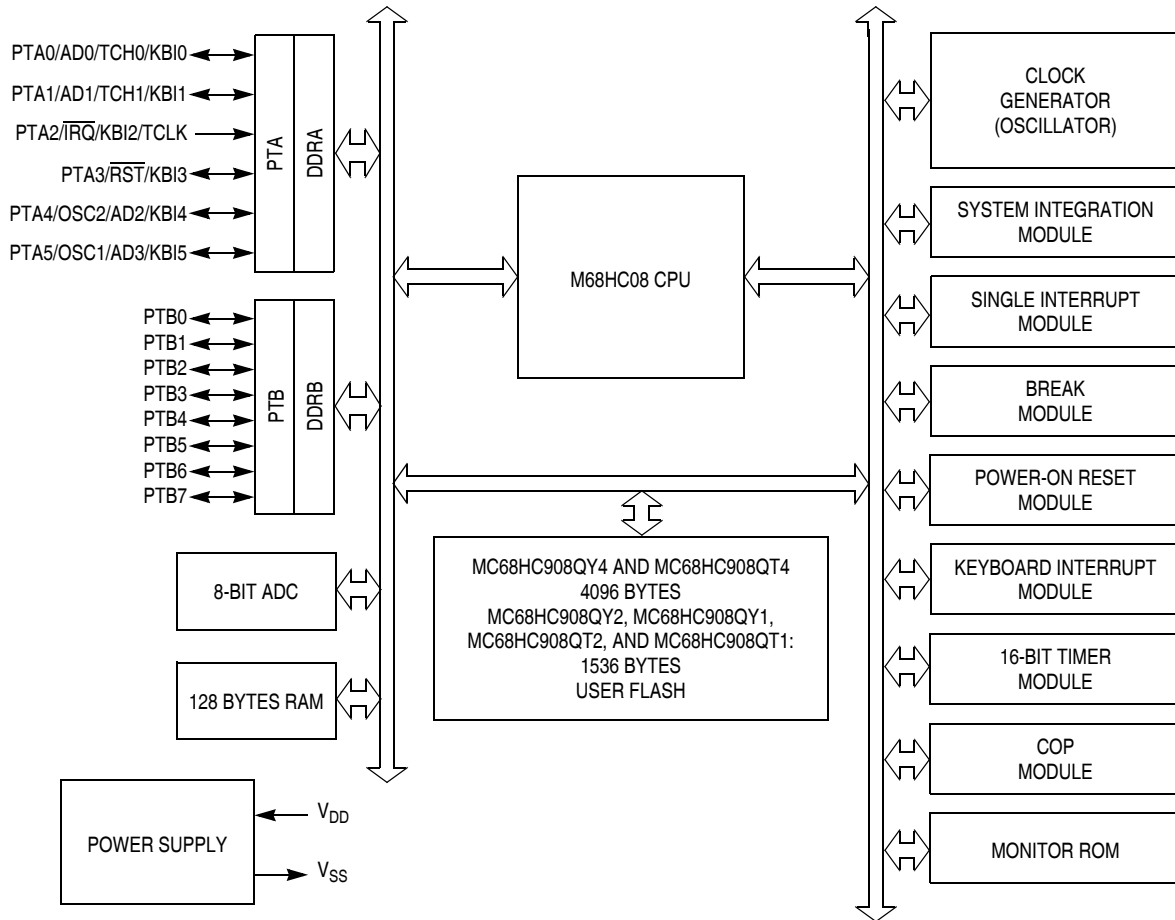
1.3 MCU Block Diagram

Figure 1-1 shows the structure of the MC68HC908QY4.

1.4 Pin Assignments

The MC68HC908QT4, MC68HC908QT2, and MC68HC908QT1 are available in 8-pin packages and the MC68HC908QY4, MC68HC908QY2, and MC68HC908QY1 in 16-pin packages. Figure 1-2 shows the pin assignment for these packages.

General Description



\overline{RST} , \overline{IRQ} : Pins have internal (about 30K Ohms) pull up

PTA[0:5]: High current sink and source capability

PTA[0:5]: Pins have programmable keyboard interrupt and pull up

PTB[0:7]: Not available on 8-pin devices – MC68HC908QT1, MC68HC908QT2, and MC68HC908QT4 (see note in [12.1 Introduction](#))

ADC: Not available on the MC68HC908QY1 and MC68HC908QT1

Figure 1-1. Block Diagram

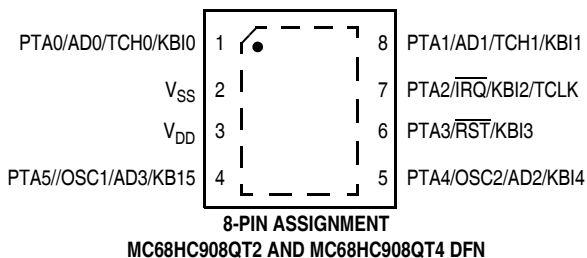
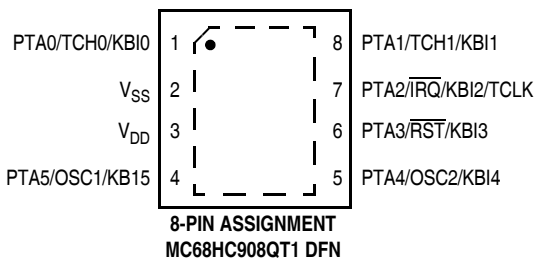
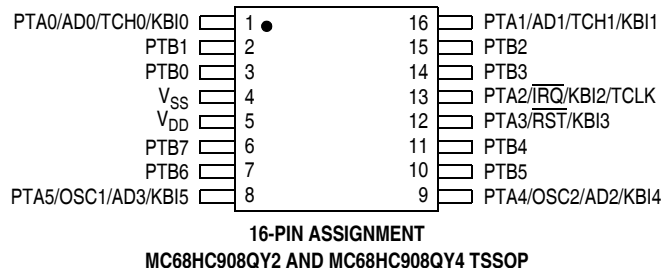
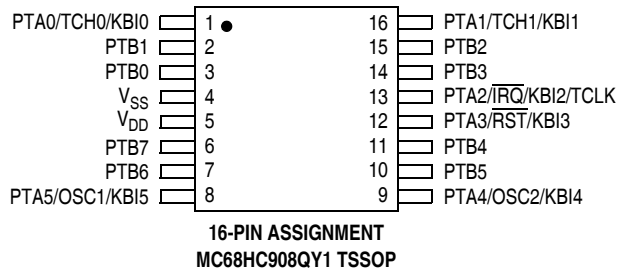
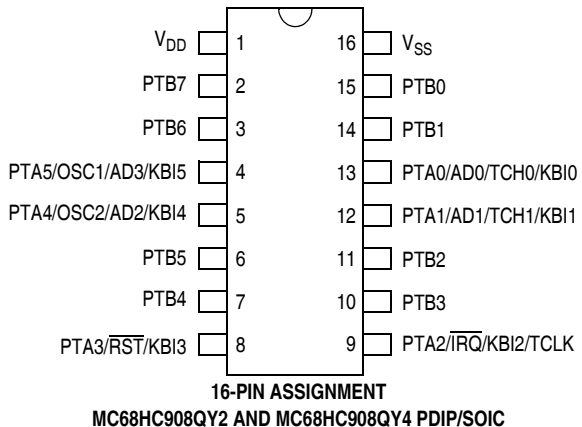
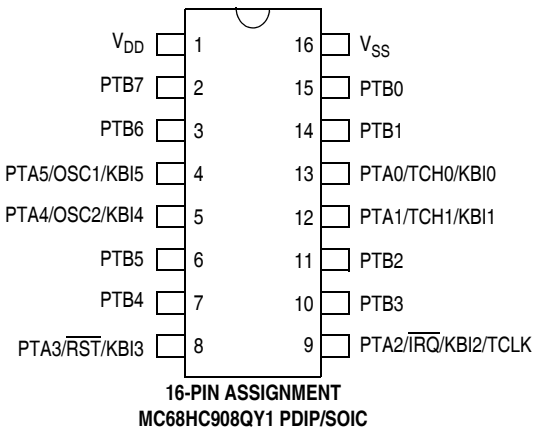
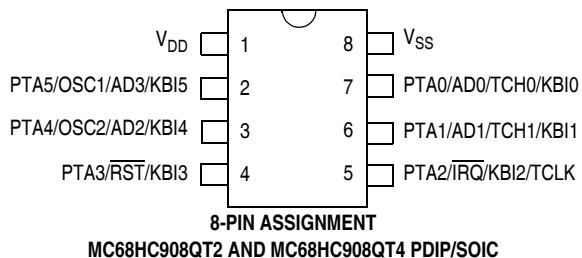
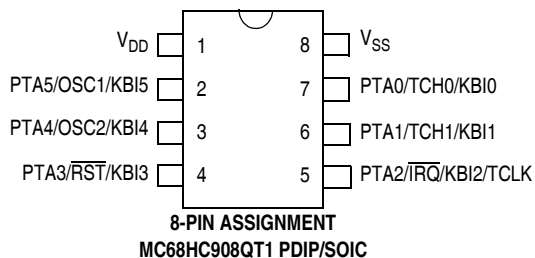


Figure 1-2. MCU Pin Assignments

1.5 Pin Functions

Table 1-2 provides a description of the pin functions.

Table 1-2. Pin Functions

Pin Name	Description	Input/Output
V _{DD}	Power supply	Power
V _{SS}	Power supply ground	Power
PTA0	PTA0 — General purpose I/O port	Input/Output
	AD0 — A/D channel 0 input	Input
	TCH0 — Timer Channel 0 I/O	Input/Output
	KBI0 — Keyboard interrupt input 0	Input
PTA1	PTA1 — General purpose I/O port	Input/Output
	AD1 — A/D channel 1 input	Input
	TCH1 — Timer Channel 1 I/O	Input/Output
	KBI1 — Keyboard interrupt input 1	Input
PTA2	PTA2 — General purpose input-only port	Input
	\overline{IRQ} — External interrupt with programmable pullup and Schmitt trigger input	Input
	KBI2 — Keyboard interrupt input 2	Input
	TCLK — Timer clock input	Input
PTA3	PTA3 — General purpose I/O port	Input/Output
	\overline{RST} — Reset input, active low with internal pullup and Schmitt trigger	Input
	KBI3 — Keyboard interrupt input 3	Input
PTA4	PTA4 — General purpose I/O port	Input/Output
	OSC2 — XTAL oscillator output (XTAL option only) RC or internal oscillator output (OSC2EN = 1 in PTAPUE register)	Output Output
	AD2 — A/D channel 2 input	Input
	KBI4 — Keyboard interrupt input 4	Input
PTA5	PTA5 — General purpose I/O port	Input/Output
	OSC1 — XTAL, RC, or external oscillator input	Input
	AD3 — A/D channel 3 input	Input
	KBI5 — Keyboard interrupt input 5	Input
PTB[0:7] ⁽¹⁾	8 general-purpose I/O ports	Input/Output

1. The PTB pins are not available on the 8-pin packages (see note in [12.1 Introduction](#)).

1.6 Pin Function Priority

Table 1-3 is meant to resolve the priority if multiple functions are enabled on a single pin.

NOTE

Upon reset all pins come up as input ports regardless of the priority table.

Table 1-3. Function Priority in Shared Pins

Pin Name	Highest-to-Lowest Priority Sequence
PTA0	AD0 → TCH0 → KBI0 → PTA0
PTA1	AD1 → TCH1 → KBI1 → PTA1
PTA2	$\overline{\text{IRQ}}$ → KBI2 → TCLK → PTA2
PTA3	$\overline{\text{RST}}$ → KBI3 → PTA3
PTA4	OSC2 → AD2 → KBI4 → PTA4
PTA5	OSC1 → AD3 → KBI5 → PTA5

Chapter 2

Memory

2.1 Introduction

The central processor unit (CPU08) can address 64 Kbytes of memory space. The memory map, shown in [Figure 2-1](#), includes:

- 4096 bytes of user FLASH for MC68HC908QT4 and MC68HC908QY4
- 1536 bytes of user FLASH for MC68HC908QT2, MC68HC908QT1, MC68HC908QY2, and MC68HC908QY1
- 128 bytes of random access memory (RAM)
- 48 bytes of user-defined vectors, located in FLASH
- 416 bytes of monitor read-only memory (ROM)
- 1536 bytes of FLASH program and erase routines, located in ROM

2.2 Unimplemented Memory Locations

Accessing an unimplemented location can have unpredictable effects on MCU operation. In [Figure 2-1](#) and in register figures in this document, unimplemented locations are shaded.

2.3 Reserved Memory Locations

Accessing a reserved location can have unpredictable effects on MCU operation. In [Figure 2-1](#) and in register figures in this document, reserved locations are marked with the word Reserved or with the letter R.